

TOSHIBA Transistor Silicon NPN·PNP Epitaxial Type  
(PCT process) (Bias Resistor built-in Transistor)

# RN49J2FS

Switching Applications

Inverter Circuit Applications

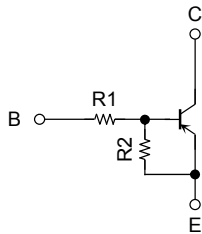
Interface Circuit Applications

Driver Circuit Applications

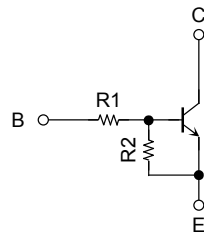
- Two devices are incorporated into a fine pitch Small Mold (6 pin) package.
- Incorporating a bias resistor into a transistor reduces parts count. Reducing the parts count enable the manufacture of ever more compact equipment and save assembly cost.

## Equivalent Circuit and Bias Resistor Values

**Q1**



**Q2**

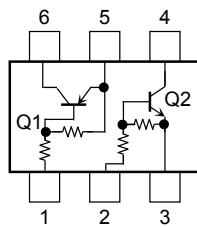


R1: 47 kΩ

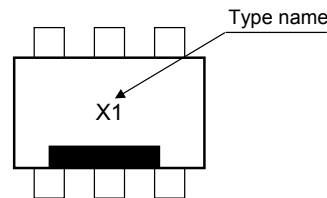
R2: 47 kΩ

(Q1, Q2 common)

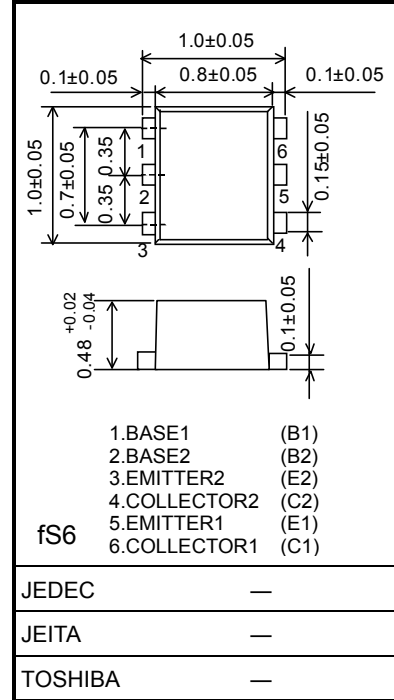
## Equivalent Circuit (top view)



## Marking



Unit: mm



Weight: 1.0 mg (typ.)

## Absolute Maximum Ratings (Ta = 25°C) (Q1)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CB0</sub>	-20	V
Collector-emitter voltage	V <sub>CE0</sub>	-20	V
Emitter-base voltage	V <sub>EB0</sub>	-10	V
Collector current	I <sub>C</sub>	-50	mA

## Absolute Maximum Ratings (Ta = 25°C) (Q2)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CB0</sub>	20	V
Collector-emitter voltage	V <sub>CE0</sub>	20	V
Emitter-base voltage	V <sub>EB0</sub>	10	V
Collector current	I <sub>C</sub>	50	mA

## Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 common)

Characteristics	Symbol	Rating	Unit
Collector power dissipation	P <sub>C</sub> (Note 1)	50	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C

Note 1: Total rating

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

**Electrical Characteristics (Ta =25°C) (Q1)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = -20\text{ V}, I_E = 0$	—	—	-100	nA
	$I_{CEO}$	$V_{CE} = -20\text{ V}, I_B = 0$	—	—	-500	
Emitter cut-off current	$I_{EBO}$	$V_{EB} = -10\text{ V}, I_C = 0$	-0.088	—	-0.133	mA
DC current gain	$h_{FE}$	$V_{CE} = -5\text{ V}, I_C = -10\text{ mA}$	120	—	—	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -5\text{ mA}, I_B = -0.25\text{ mA}$	—	—	-0.15	V
Input voltage (ON)	$V_I(ON)$	$V_{CE} = -0.2\text{ V}, I_C = -5\text{ mA}$	-1.2	—	-3.6	V
Input voltage (OFF)	$V_I(OFF)$	$V_{CE} = -5\text{ V}, I_C = -0.1\text{ mA}$	-0.8	—	-1.5	V
Collector output capacitance	$C_{ob}$	$V_{CB} = -10\text{ V}, I_E = 0, f = 1\text{ MHz}$	—	1.2	—	pF

**Electrical Characteristics (Ta =25°C) (Q2)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = 20\text{ V}, I_E = 0$	—	—	100	nA
	$I_{CEO}$	$V_{CE} = 20\text{ V}, I_B = 0$	—	—	500	
Emitter cut-off current	$I_{EBO}$	$V_{EB} = 10\text{ V}, I_C = 0$	0.088	—	0.133	mA
DC current gain	$h_{FE}$	$V_{CE} = 5\text{ V}, I_C = 10\text{ mA}$	120	—	—	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 5\text{ mA}, I_B = 0.25\text{ mA}$	—	—	0.15	V
Input voltage (ON)	$V_I(ON)$	$V_{CE} = 0.2\text{ V}, I_C = 5\text{ mA}$	1.2	—	3.6	V
Input voltage (OFF)	$V_I(OFF)$	$V_{CE} = 5\text{ V}, I_C = 0.1\text{ mA}$	0.8	—	1.5	V
Collector output capacitance	$C_{ob}$	$V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$	—	1.2	—	pF

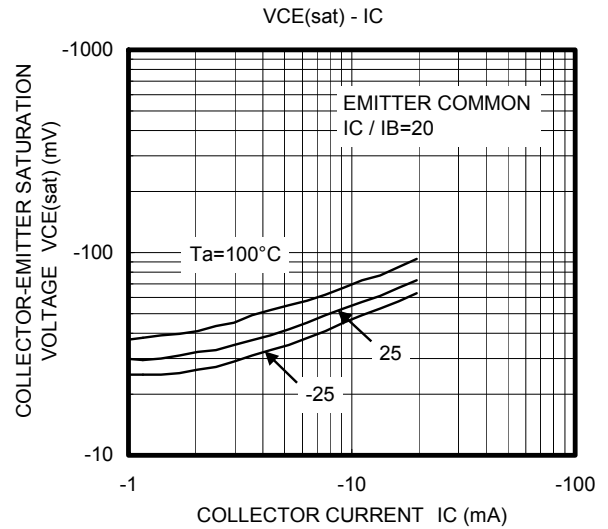
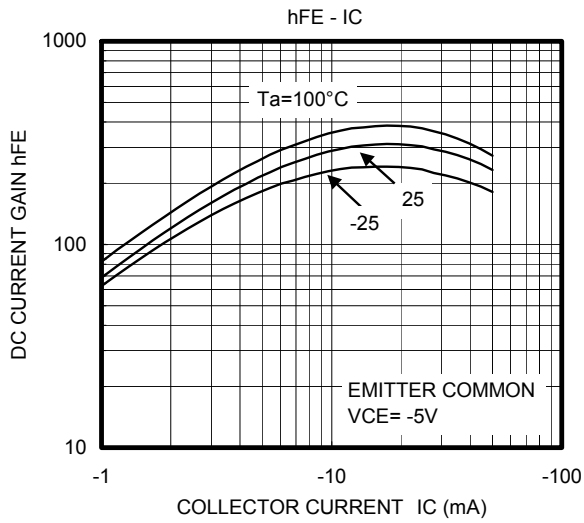
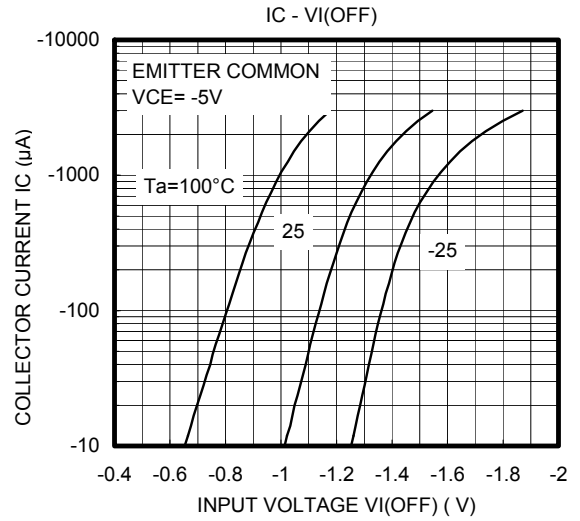
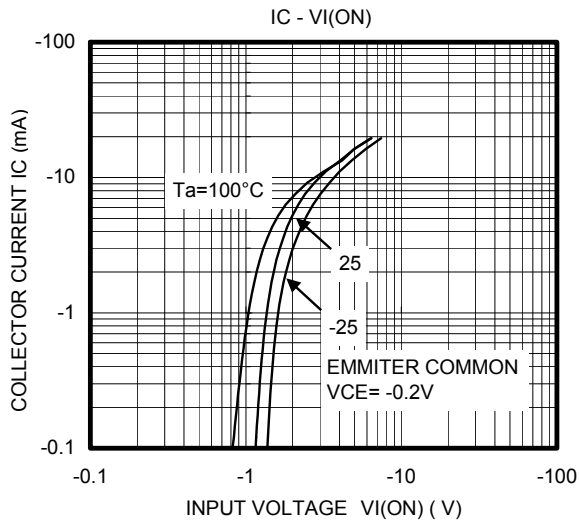
**Electrical Characteristics (Ta =25°C) (Q1, Q2 common)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input resistor	R1	—	37.6	47	56.4	kΩ
Resistor ratio	R1/R2	—	0.8	1.0	1.2	

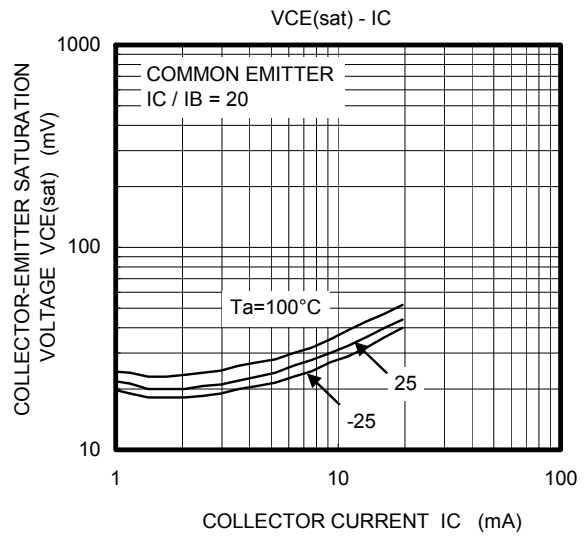
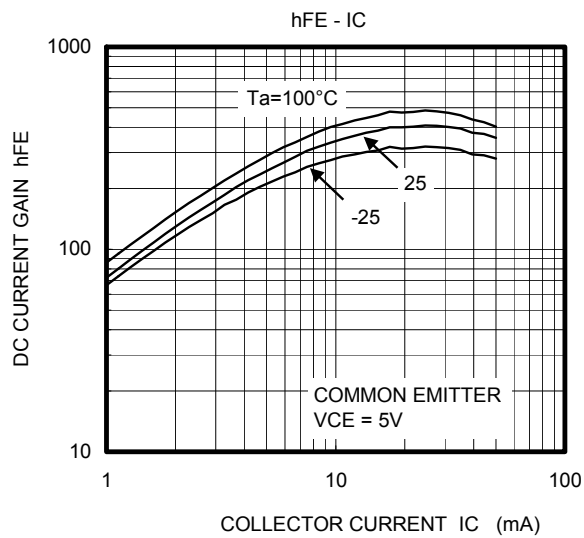
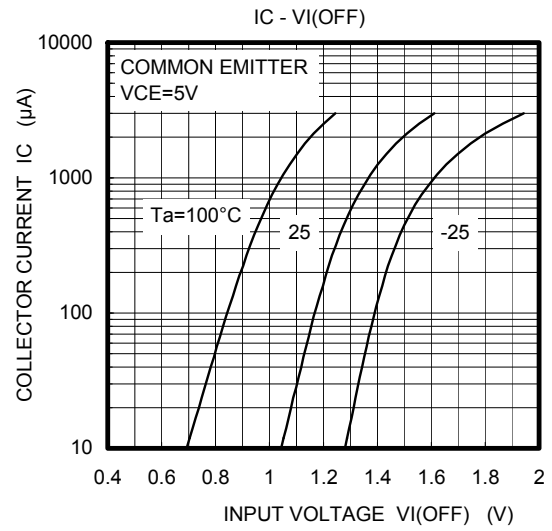
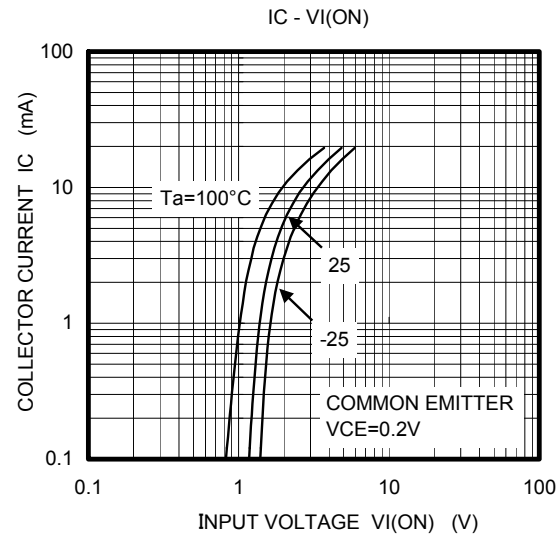
**Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Q1



**Q2**



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